10-bit bus switch with 5-bit output enables Rev. 2 — 16 December 2011

Product data sheet

1. **General description**

The 74CBTLV3384 is a dual 5-pole, single-throw bus switch. The device features two output enable inputs (nOE) that each control five switch channels. The switches are disabled when the associated nOE input is HIGH. Schmitt-trigger action at control inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. **Features and benefits**

- Supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



74CBTLV3384

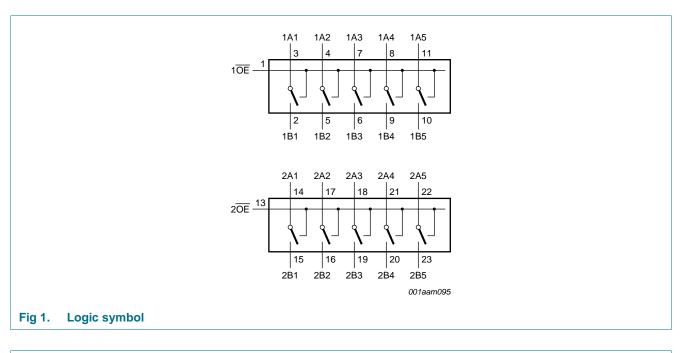
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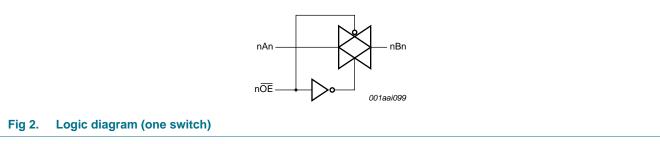
Ordering information 3.

Type number	Package							
	Temperature range	Name	Description	Version				
74CBTLV3384DK	–40 °C to +125 °C	SSOP24[1]	plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT556-1				
74CBTLV3384PW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1				
74CBTLV3384BQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm	SOT815-1				

[1] Also known as QSOP24 package

Functional diagram 4.

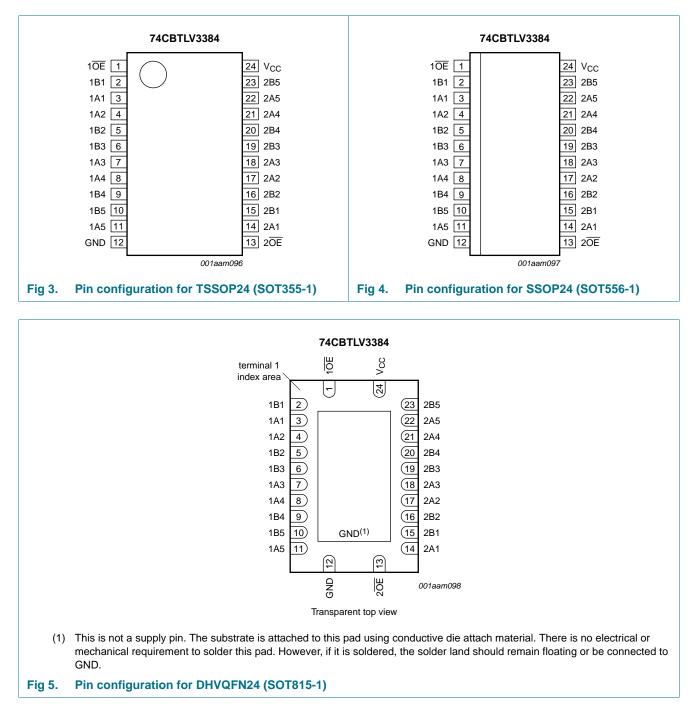




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5. Pinning information

5.1 Pinning



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5.2 Pin description

Table 2. Pin descr	ription	
Symbol	Pin	Description
1 <u>0E</u> , 2 <u>0E</u>	1, 13	output enable input (active LOW)
1A1 to 1A5	3, 4, 7, 8, 11	data input/output (A port)
2A1 to 2A5	14, 17, 18, 21, 22	data input/output (A port)
1B1 to 1B5	2, 5, 6, 9, 10	data input/output (B port)
2B1 to 2B5	15, 16, 19, 20, 23	data input/output (B port)
GND	12	ground (0 V)
V _{CC}	24	positive supply voltage

6. Functional description

Table 3. Function selection^[1]

		Input/output		
1 <mark>0E</mark>	2 0E	1An, 1Bn	2An, 2Bn	
L	L	1An = 1Bn	2An = 2Bn	
L	Н	1An = 1Bn	Z	
Н	L	Z	2An = 2Bn	
Н	Н	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

					,
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage	enable and disable mode	<u>[1]</u> –0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < -0.5 V	-50	-	mA
I _{SK}	switch clamping current	V _I < -0.5 V	-50	-	mA
I _{SW}	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I _{CC}	supply current		-	+100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SSOP24 and TSSOP24 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

For DHVQFN24 package: P_{tot} derates linearly at 4.5 mW/K above 60 °C.

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8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		2.3	3.6	V
VI	input voltage		0	3.6	V
V _{SW}	switch voltage	enable and disable mode	0	V_{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 2.3 V to 3.6 V	<u>[1]</u> _	200	ns/V
					-

[1] Applies to control signal levels.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

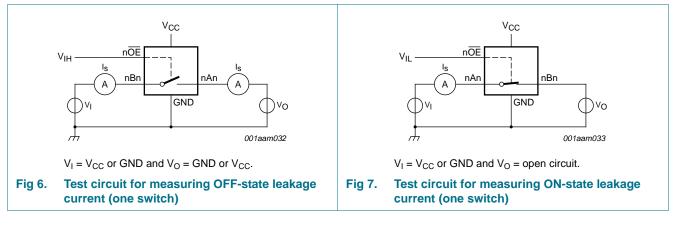
Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	$T_{amb} = -40 \circ$	C to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	1
V _{IH}	HIGH-level	V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	input voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	voltage	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.9	-	0.9	V
I _I	input leakage current	pin n \overline{OE} ; V ₁ = GND to V _{CC} ; V _{CC} = 3.6 V	-	-	±1	-	±20	μA
I _{S(OFF)}	OFF-state leakage current	V_{CC} = 3.6 V; see <u>Figure 6</u>	-	-	±1	-	±20	μΑ
I _{S(ON)}	ON-state leakage current	V_{CC} = 3.6 V; see <u>Figure 7</u>	-	-	±1	-	±20	μΑ
I _{OFF}	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$	-	-	±10	-	±50	μΑ
I _{CC}	supply current		-	-	10	-	50	μΑ
ΔI_{CC}	additional supply current	pin $\overline{\text{OE}}$; V _I = V _{CC} - 0.6 V; V _{SW} = GND or V _{CC} ; V _{CC} = 3.6 V	[2] _	-	300	-	2000	μA
Cl	input capacitance	pin n \overline{OE} ; V _{CC} = 3.3 V; V _I = 0 V to 3.3 V	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	5.2	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance	V_{CC} = 3.3 V; V_{I} = 0 V to 3.3 V	-	14.3	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.

[2] One input at 3 V, other inputs at $V_{CC} \mbox{ or GND}.$

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9.1 Test circuits



9.2 ON resistance

Table 7.Resistance Ron

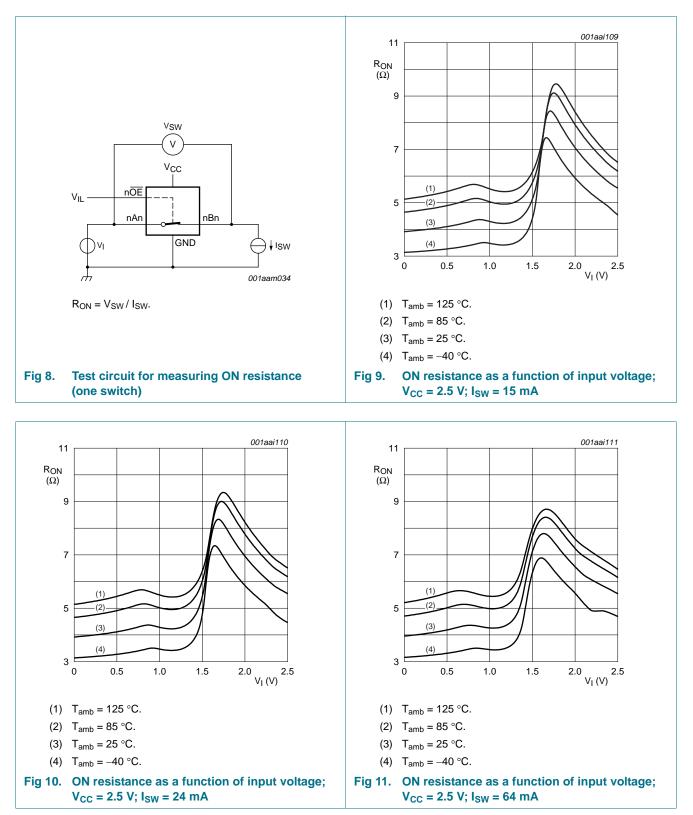
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	Conditions	T _{amb} =	–40 °C to	+85 °C	T _{amb} = -40 °C to +125 °C		Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
	V _{CC} = 2.3 V to 2.7 V; [2] see <u>Figure 9</u> to <u>Figure 11</u>							
		$I_{SW} = 64 \text{ mA}; V_{I} = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω
		I_{SW} = 15 mA; V_{I} = 1.7 V	-	8.4	40	-	60.0	Ω
		$V_{CC} = 3.0 V$ to 3.6 V; see <u>Figure 12</u> to <u>Figure 14</u>						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω
		I_{SW} = 15 mA; V_{I} = 2.4 V	-	6.2	15	-	25.5	Ω

[1] Typical values are measured at T_{amb} = 25 $^\circ C$ and nominal $V_{CC}.$

[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

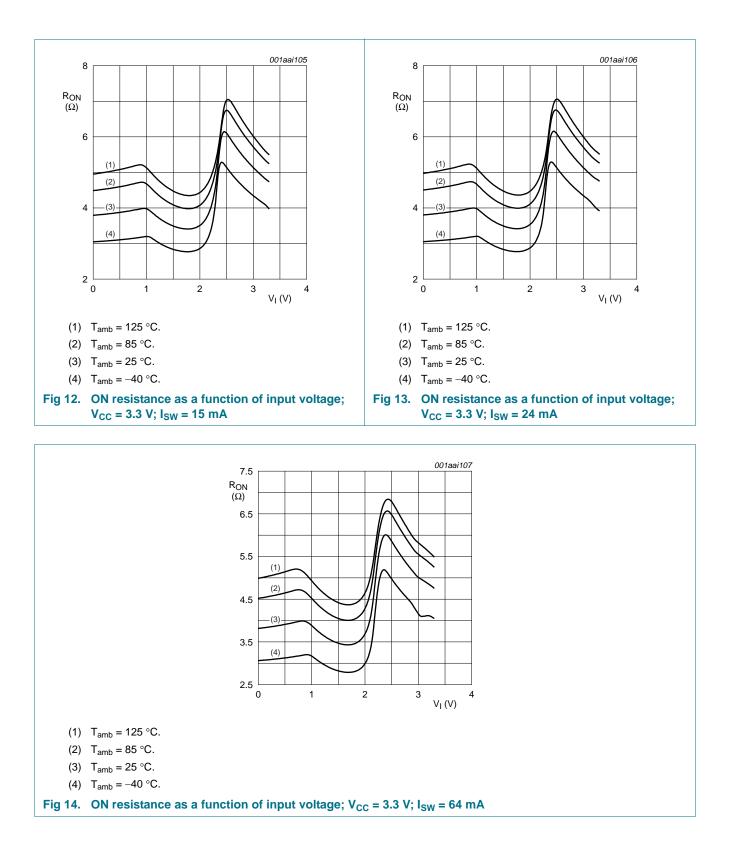
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9.3 ON resistance test circuit and graphs

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10. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 17

Symbol	Parameter	Conditions		T _{amb} = ·	T _{amb} = -40 °C to +85 °C		$T_{amb} = -40$ °	°C to +125 °C	Unit
					Typ[1]	Max	Min	Max	-
t _{pd}	propagation delay	nAn to nBn or nBn to nAn; see <u>Figure 15</u>	<u>[2][3]</u>						
		V_{CC} = 2.3 V to 2.7 V		-	-	0.13	-	0.20	ns
		V_{CC} = 3.0 V to 3.6 V		-	-	0.20	-	0.31	ns
t _{en} enable time	enable time	n <mark>OE</mark> to nAn or nBn; see <u>Figure 16</u>	<u>[4]</u>						
		V_{CC} = 2.3 V to 2.7 V		1.0	3.0	5.0	1.0	7.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.6	4.3	1.0	6.0	ns
t _{dis}	disable time	nOE to nAn or nBn; see <u>Figure 16</u>	[5]						
		V_{CC} = 2.3 V to 2.7 V		1.0	2.6	5.5	1.0	7.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	3.2	5.5	1.0	7.5	ns

[1] All typical values are measured at T_{amb} = 25 $^\circ C$ and at nominal $V_{CC}.$

[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

 $[3] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

 $\label{eq:tensor} [4] \quad t_{en} \text{ is the same as } t_{PZH} \text{ and } t_{PZL}.$

[5] t_{dis} is the same as t_{PHZ} and t_{PLZ} .

11. Waveforms

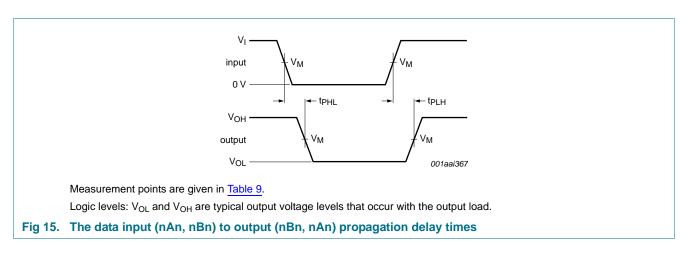


Table 9. Measurement points

Supply voltage	Input			ly voltage Input Output			
V _{CC}	V _M	VI	$t_r = t_f$	V _M	V _X	V _Y	
2.3 V to 2.7 V	$0.5V_{CC}$	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V	
3.0 V to 3.6 V	$0.5V_{CC}$	V _{CC}	\leq 2.0 ns	$0.5V_{CC}$	V _{OL} + 0.3 V	V _{OH} – 0.3 V	

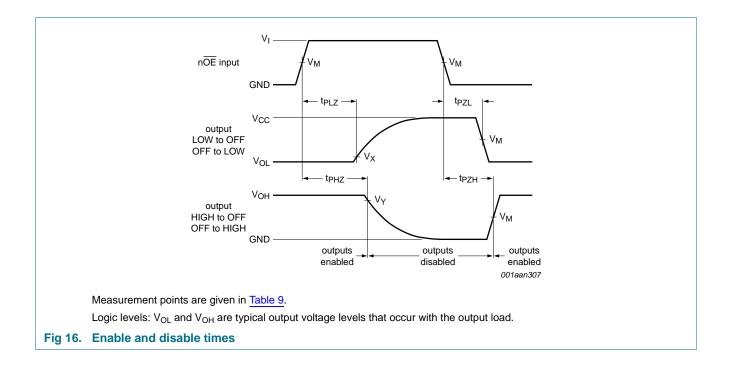
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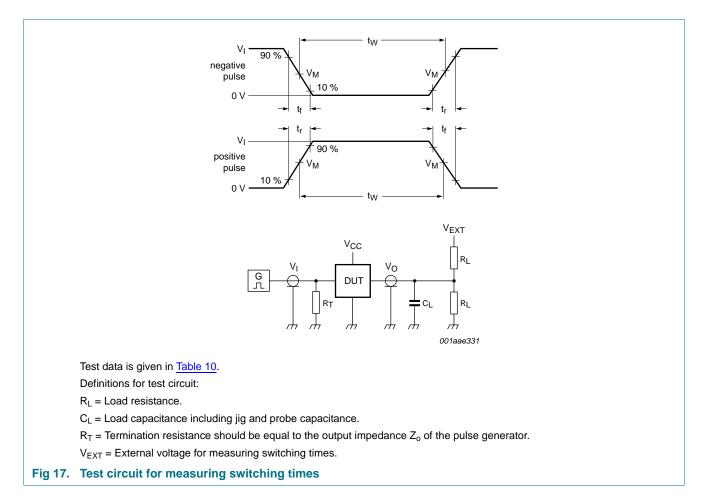


Table 10. Test data

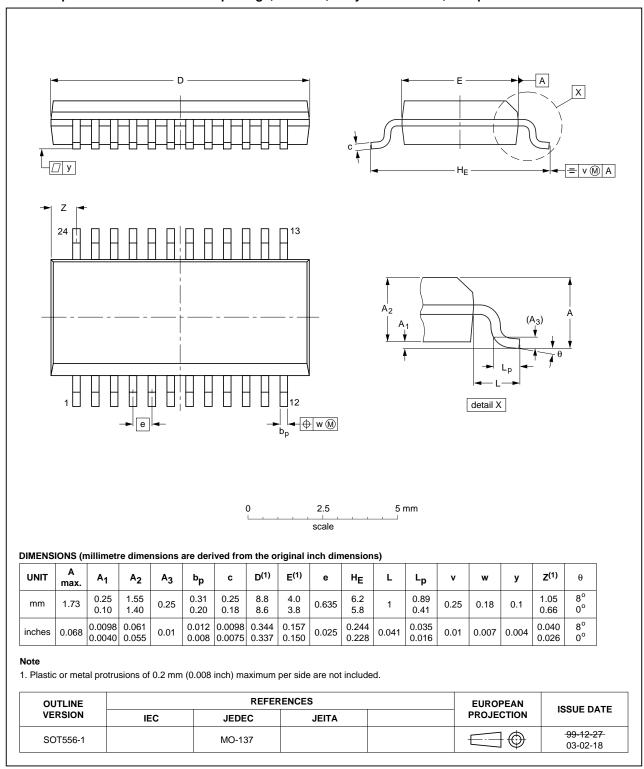
Supply voltage	Load		V _{EXT}		
V _{cc}	CL	R _L	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V _{CC}
3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V _{CC}

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12. Package outline



SSOP24: plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm SOT556-1

Fig 18. Package outline SOT556-1 (SSOP24)

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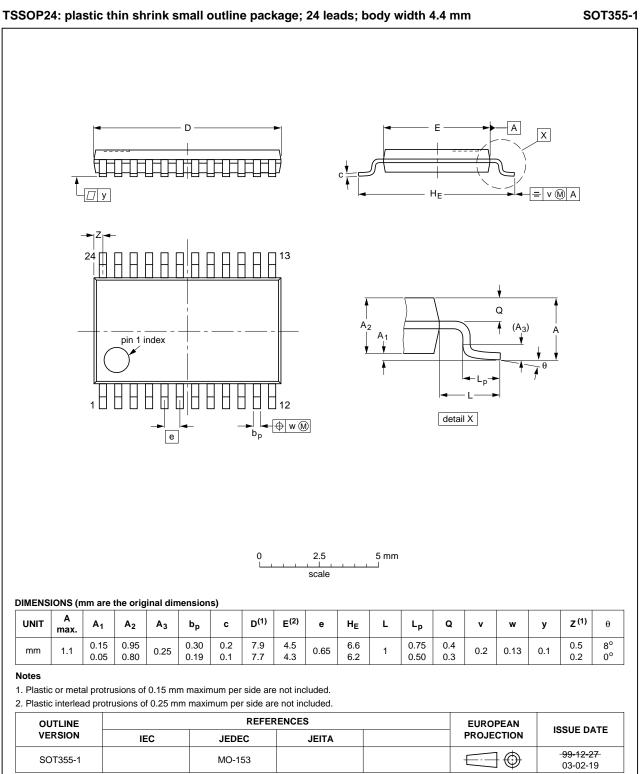


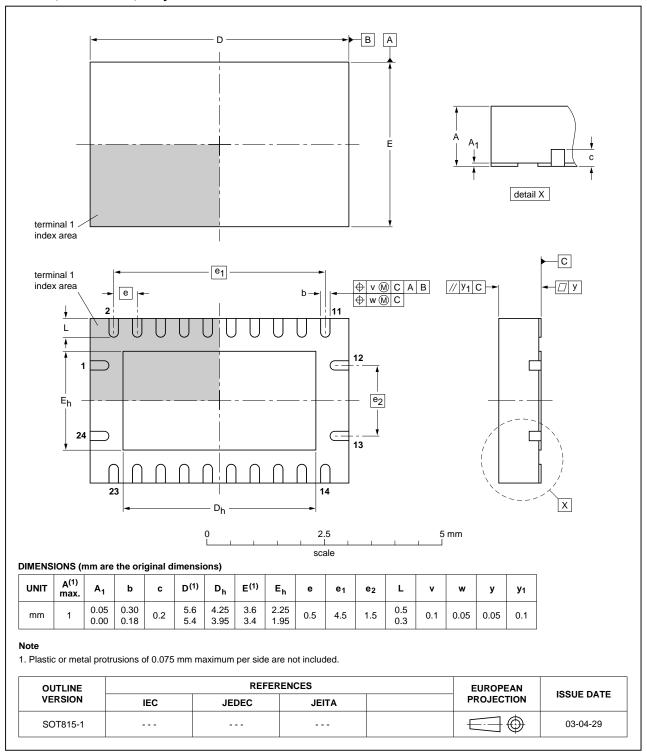
Fig 19. Package outline SOT355-1 (TSSOP24)

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SOT815-1

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DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 20. Package outline SOT815-1 (DHVQFN24)

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13. Abbreviations

Table 11.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 12. Revision I	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74CBTLV3384 v.2	20111216	Product data sheet	-	74CBTLV3384 v.1
Modifications:	 Legal pages 	s updated.		
74CBTLV3384 v.1	20101230	Product data sheet	-	-

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15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
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[2] The term 'short data sheet' is explained in section "Definitions".

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